RoHS

HALOGEN FREE

GREEN

(5-2008)

### Vishay Dale Thin Film

## ThermaWick® Thermal Jumper Surface Mount Chip



#### **LINKS TO ADDITIONAL RESOURCES**







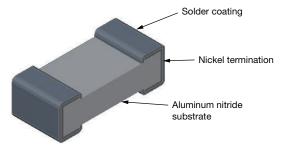






THJP surface-mount chips are designed to provide an electrically isolated thermal conductive pathway to a ground plane or heat sink while maintaining the electrical isolation of the device. The devices are constructed with aluminum nitride substrates in both SnPb and Pb-free wraparound termination styles. The low capacitance of the device makes them an excellent choice for high frequency and thermal ladder applications. Custom sizes available.

#### CONSTRUCTION



#### **FEATURES**

- Electrically isolated thermal conductor
- High thermal conductivity AIN substrate (170 W/mK)
- Electrically isolated terminations (> 999 MΩ)
- Low capacitance
- Available with SnPb or lead (Pb)-free wrap terminations
- AEC-Q200 qualified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **APPLICATIONS**

- · Power supplies and converters
- RF amplifiers
- Synthesizers
- Switch mode power supplies
- · Pin and laser diodes
- Filters

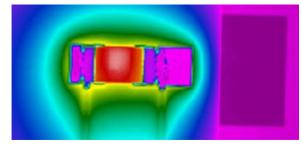
# FUNCTIONAL APPLICATIONS / CONNECTION OPTIONS

- Component to heat sink
- · Component to case
- · Component to ground plane
- Pad to pad
- Pad to via
- Pad to trace

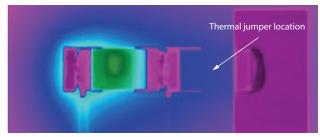
#### **HEAT TRANSFER DEMONSTRATION**

Chip surface temperature was measured using a FLIR SC645 thermal imaging system under ambient conditions. The devices were mounted to an FR4 test card designed with a 25 mm x 19 mm copper heat sink. Power was supplied to device to cause the surface temperature to stabilize at 150 °C. The device was then retested at the same power level with the thermal jumper connecting the device to the heat sink.

#### Example THJP 1206 Thermal Jumper Showing 54.3 °C Surface Temperature Reduction



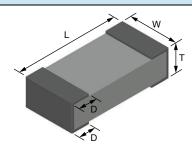
Ceramic Resistor Chip Without Thermal Jumper (149.8 °C)



Ceramic Chip Resistor With Thermal Jumper (95.5 °C)

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CASE SIZE	L	W	Т	D	WEIGHT (g)
0603	0.061 ± 0.005	$0.033 \pm 0.005$	$0.030 \pm 0.005$	0.015 ± 0.005	0.003
0612	$0.063 \pm 0.005$	0.126 ± 0.005	$0.030 \pm 0.005$	0.015 ± 0.005	0.013
0805	0.079 ± 0.005	0.047 ± 0.005	$0.030 \pm 0.005$	$0.020 \pm 0.005$	0.006
1206	0.126 ± 0.005	$0.063 \pm 0.005$	$0.030 \pm 0.005$	$0.020 \pm 0.005$	0.013
1225	0.126 ± 0.005	0.252 ± 0.005	$0.030 \pm 0.005$	$0.020 \pm 0.005$	0.052
2512	0.252 ± 0.005	0.126 ± 0.005	$0.030 \pm 0.005$	$0.020 \pm 0.005$	0.052

TYPICAL CHARACTERISTICS						
CASE SIZE	0603	0612	0805	1206	1225	2512
Thermal resistance (°C/W), T <sub>R</sub>	14	4	13	15	4	15
Thermal conductance (mW/°C), T <sub>C</sub>	70	259	77	65	259	65
Capacitance (pF)	0.07	0.26	0.15	0.07	0.26	0.07
Dielectric withstanding voltage kV <sub>AC</sub> , RMS (60 Hz)	> 1.5	> 1.5	> 1.5	> 2.5	> 1.5	> 3.5

#### Note

• 
$$T_R = \frac{L}{k (T \cdot W)}$$

where k is the thermal conductivity of AIN, 170 W/mK

$$T_C = \frac{1}{T_R}$$

STANDARD ELECTRICAL SPECIFICATIONS	
TEST	SPECIFICATIONS
Operating temperature range	-65 °C to +150 °C
Storage temperature range	-65 °C to +150 °C

STANDARD MATERIAL SPECIFICATIONS	
Substrate material	Aluminum nitride (170 W/mK)
Termination (tin / lead)	Electroplate tin / lead over electroplate nickel
Termination (lead (Pb)-free)	Electroplate tin (e3) over electroplate nickel

ENVIRONMENTAL TESTS (Vishay Performance vs. MIL-PRF-55342 / AEC-Q200 Requirements)				
ENVIRONMENTAL TEST	VIRONMENTAL TEST CONDITIONS LIMITS		TYPICAL VISHAY PERFORMANCE	
Solderability Visual	J-STD-002, method B and B1	95 %	Acceptable	
Solder mounting integrity Visual	MIL-PRF-55342, method par. 4.8.13.1	Pass / fail	Pass	
Board flex Visual	AEC-Q200, method 005	Pass / fail	Pass	





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New Global Part Numbering: THJP1206AST1  T H J P 1 2 0 6 A S T 1
GLOBAL MODEL THJP  CASE SIZE THICKNESS A = 0.030"  TERMINATION B = wraparound Sn/Pb solder with nickel termination S = wraparound Sn (e3) solder with nickel termination RoHS compliant  TAPE AND REEL TO = 100 min., 100 mult. T1 = 1000 min., 1000 mult. T5 = 500 min., 300 mult. TF = full reel TS = 100 min., 1 mult. TI = 100 min., 1 mult. TI = 100 min., 1 mult. TI = 100 min., 1 mult. TF = 100 min., 1 mult. THO = 100 min., 1 mult. TF = 100 min., 1 mult. THO = 100



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